

Radiation Hard Multichannel AlN/GaN HEMT for High Efficiency X- and Ka-Band Power Amplifiers, Phase I

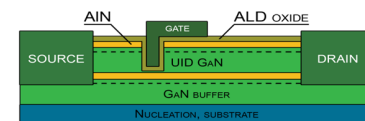
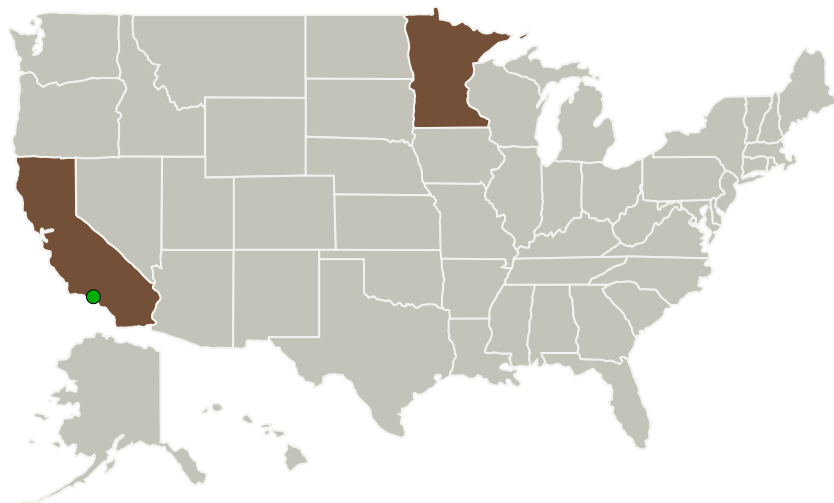
Completed Technology Project (2014 - 2014)



Project Introduction

This project is directed to the development of low-loss, high power-density Aluminum Nitride (AlN)/Gallium Nitride (GaN) heterostructure based transistors for enabling high-efficiency solid state power amplifiers (SSPA) needed for advancing capabilities of future robotic and human exploration spacecraft. The AlN/GaN heterostructure is a particularly attractive system for switch-mode applications due to the extremely high charge density, high electron mobility, high intrinsic breakdown field, and physical thinness achievable and has seen widespread investigation toward solid-state amplifiers in the recent years. However, very few innovations have been proposed with this heterostructure despite its expansive capacity for various creative device concepts. A new patent-pending multichannel AlN/GaN Field Screening High Electron Mobility Transistor (FS-HEMT) design is described. Preliminary experimental results are presented validating design principles that will eliminate current collapse phenomenon at X- and Ka-band frequencies that has plagued traditional HEMT designs and will ultimately deliver a low-loss switch-mode device.

Primary U.S. Work Locations and Key Partners



The above illustration depicts the proposed dual-channel Field-Screening HEMT device structure.

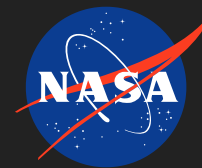
Radiation Hard Multichannel AlN/GaN HEMT for High Efficiency X- and Ka-Band Power Amplifiers Project Image

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Organizations Performing Work	Role	Type	Location
Agnitron Technology	Lead Organization	Industry	Eden Prairie, Minnesota
● Jet Propulsion Laboratory(JPL)	Supporting Organization	NASA Center	Pasadena, California

Primary U.S. Work Locations

California	Minnesota
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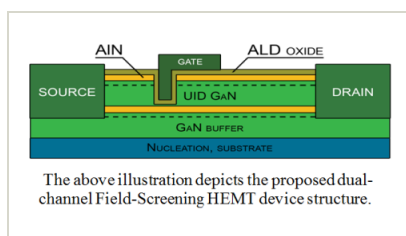
Project Transitions

**June 2014:** Project Start**December 2014:** Closed out

Closeout Documentation:

- Final Summary Chart(<https://techport.nasa.gov/file/137421>)

Images



Project Image

Radiation Hard Multichannel
AlN/GaN HEMT for High Efficiency
X- and Ka-Band Power Amplifiers
Project Image
(<https://techport.nasa.gov/image/129882>)

Organizational Responsibility

Responsible Mission Directorate:

Space Technology Mission Directorate (STMD)

Lead Organization:

Agnitron Technology

Responsible Program:

Small Business Innovation Research/Small Business Tech Transfer

Project Management

Program Director:

Jason L Kessler

Program Manager:

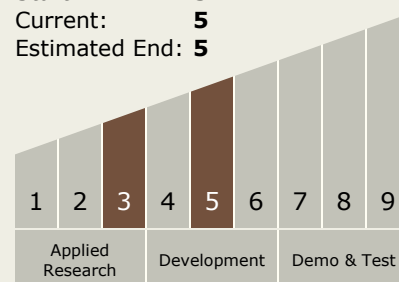
Carlos Torrez

Principal Investigator:

Andrei Osinsky

Technology Maturity (TRL)

Start: 3
Current: 5
Estimated End: 5



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Technology Areas

Primary:

- TX05 Communications, Navigation, and Orbital Debris Tracking and Characterization Systems
 - └ TX05.2 Radio Frequency
 - └ TX05.2.2 Power-Efficiency

Target Destinations

The Sun, Earth, The Moon, Mars, Others Inside the Solar System, Outside the Solar System